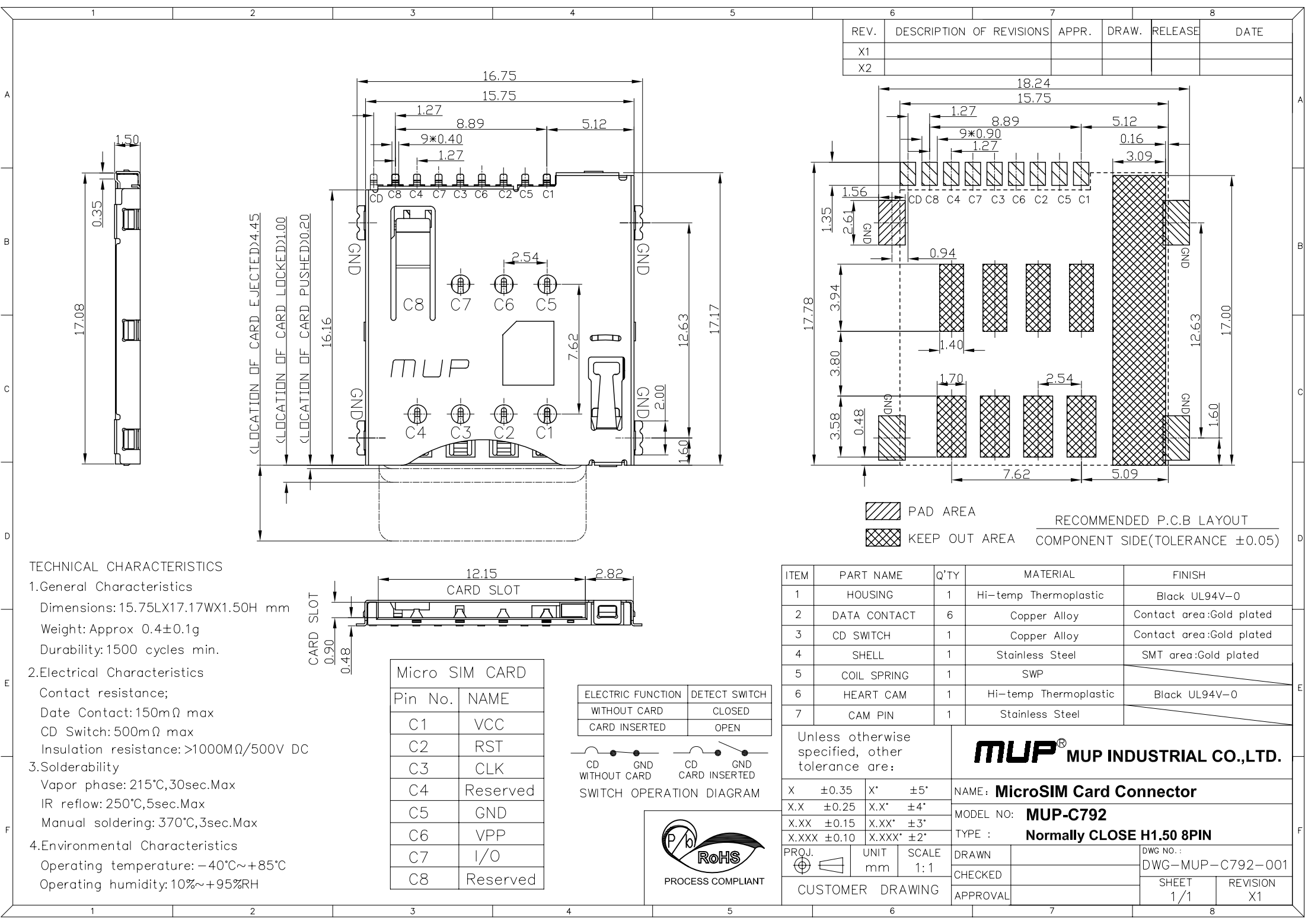
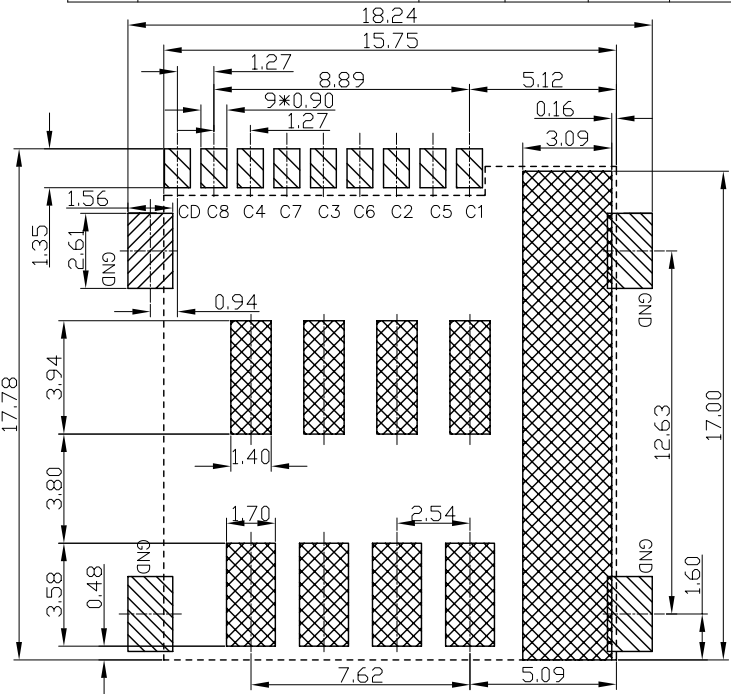




REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



RECOMMENDED P.C.B. LAYOUT
COMPONENT SIDE(TOLERANCE ±0.05)

TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions: 15.75LX17.17WX1.50H mm
Weight: Approx 0.4±0.1g
Durability:1500 cycles min.

2.Electrical Characteristics

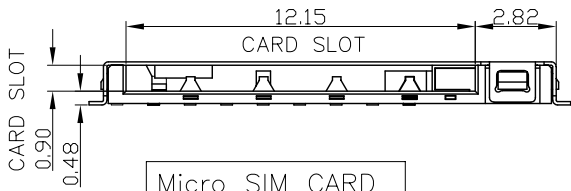
Contact resistance;
Date Contact:150mΩ max
CD Switch: 500mΩ max
Insulation resistance: >1000MΩ/500V DC

3.Solderability

Vapor phase: 215°C,30sec.Max
IR reflow: 250°C,5sec.Max
Manual soldering: 370°C,3sec.Max

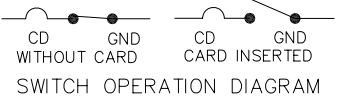
4.Environmental Characteristics

Operating temperature: -40°C~+85°C
Operating humidity: 10%~+95%RH



Micro SIM CARD	
Pin No.	NAME
C1	VCC
C2	RST
C3	CLK
C4	Reserved
C5	GND
C6	VPP
C7	I/O
C8	Reserved

ELECTRIC FUNCTION	DETECT SWITCH
WITHOUT CARD	CLOSED
CARD INSERTED	OPEN



ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	CD SWITCH	1	Copper Alloy	Contact area:Gold plated
4	SHELL	1	Stainless Steel	SMT area:Gold plated
5	COIL SPRING	1	SWP	
6	HEART CAM	1	Hi-temp Thermoplastic	Black UL94V-0
7	CAM PIN	1	Stainless Steel	

Unless otherwise specified, other tolerance are:

MUP MUP INDUSTRIAL CO.,LTD.

NAME: **MicroSIM Card Connector**

MODEL NO: **MUP-C792**

TYPE : **Normally CLOSE H1.50 8PIN**

PROJ.	UNIT	SCALE	DRAWN	DWG NO.:
mm	mm	1:1		DWG-MUP-C792-001
CUSTOMER DRAWING			CHECKED	SHEET
			APPROVAL	1/1
				REVISION
				X1